MOSFET – Power, N-Channel, SUPERFET III, Easy Drive

650 V, 17 A, 190 m Ω

FCPF190N65S3R0L

Description

SUPERFET III MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate. Consequently, SUPERFET III MOSFET Easy drive series helps manage EMI issues and allows for easier design implementation.

Features

- 700 V @ T_J = 150°C
- Typ. $R_{DS(on)} = 159 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. Q_g = 33 nC)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 300 pF)
- 100% Avalanche Tested
- This Device is Pb-Free and is RoHS Compliant

Applications

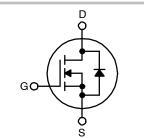
- Computing / Display Power Supplies
- Telecom / Server Power Supplies
- Industrial Power Supplies
- Lighting / Charger / Adapter



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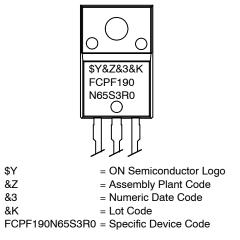
V _{DSS}	R _{DS(on)} MAX	I _D MAX
650 V	190 mΩ @ 10 V	17 A





TO-220 CASE 340BF

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Parameter		Value	Unit
V _{DSS}	Drain to Source Voltage		650	V
V _{GSS}	Gate to Source Voltage	DC	±30	V
		AC ($f > 1 Hz$)	±30	V
ID	Drain Current	Continuous (T _C = 25°C)	17*	А
		Continuous (T _C = 100°C)	11*	
I _{DM}	Drain Current	Pulsed (Note 1)	42.5*	А
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		76	mJ
I _{AS}	Avalanche Current (Note 2)		2.5	А
E _{AR}	Repetitive Avalanche Energy (Note 1)		1.44	mJ
dv/dt	MOSFET dv/dt		100	V/ns
	Peak Diode Recovery dv/dt (Note 3)		20	
PD	Power Dissipation	$T_{\rm C} = 25^{\circ}{\rm C}$	33	W
		Derate Above 25°C	1.15	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		300	°C

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. *Drain current limited by maximum junction temperature.

1. Repetitive rating: pulse-width limited by maximum junction temperature.

2. $I_{AS} = 2.5 \text{ A}$, $R_G = 25 \Omega$, starting $T_J = 25^{\circ}\text{C}$. 3. $I_{SD} \leq 8.5 \text{ A}$, di/dt $\leq 200 \text{ A/ms}$, $V_{DD} \leq 400 \text{ V}$, starting $T_J = 25^{\circ}\text{C}$.

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
Rejc	Thermal Resistance, Junction to Case, Max.	3.76	°C/W
Reja	Thermal Resistance, Junction to Ambient, Max.	62.5	,

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FCPF190N65S3R0L	FCPF190N65S3R0	TO-220F	Tube	N/A	N/A	50 Units

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHARACT	ERISTICS					
BV _{DSS}	Drain to Source Breakdown Voltage	V_{GS} = 0 V, I_D = 1 mA, T_J = 25°C	650			V
		V_{GS} = 0 V, I_{D} = 1 mA, T_{J} = 150°C	700			V
$\Delta BV_{DSS} / \Delta T_{J}$	Breakdown Voltage Temperature Coefficient	$I_D = 1$ mA, Referenced to 25°C		0.6		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 650 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	μA
		V _{DS} = 520 V, T _C = 125°C		0.89		1
I _{GSS}	Gate to Body Leakage Current	V_{GS} = ±30 V, V_{DS} = 0 V			±100	nA
ON CHARACTE	RISTICS					
V _{GS(th)}	Gate Threshold Voltage	V_{GS} = V_{DS} , I_D = 0.39 mA	2.5		4.5	V
R _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 8.5 A		159	190	mΩ
9 _{FS}	Forward Transconductance	V _{DS} = 20 V, I _D = 8.5 A		10		S
YNAMIC CHA	RACTERISTICS		1			•
C _{iss}	Input Capacitance	V_{DS} = 400 V, V_{GS} = 0 V,		1350		pF
C _{oss}	Output Capacitance	f = 1 MHz		30		pF
C _{oss(eff.)}	Effective Output Capacitance	V_{DS} = 0 V to 400 V, V_{GS} = 0 V		300		pF
C _{oss(er.)}	Energy Related Output Capacitance	V_{DS} = 0 V to 400 V, V_{GS} = 0 V		43		pF
Q _{g(tot)}	Total Gate Charge at 10V	V _{DS} = 400 V, I _D = 8.5 A,		33		nC
Q _{gs}	Gate to Source Gate Charge	Int ID = 1 mA, Referenced to 25°C VDS = 650 V, VGS = 0 V VDS = 520 V, TC = 125°C VGS = ±30 V, VDS = 0 V VGS = 10 V, ID = 0.39 mA VGS = 10 V, ID = 8.5 A VDS = 20 V, ID = 8.5 A VDS = 0 V to 400 V, VGS = 0 V VDS = 0 V to 400 V, VGS = 0 V VDS = 0 V to 400 V, VGS = 0 V VDS = 0 V to 400 V, VGS = 0 V VDS = 0 V to 400 V, VGS = 0 V VDS = 0 V to 400 V, VGS = 0 V VDS = 0 V to 400 V, ID = 8.5 A, VGS = 0 V VDS = 400 V, ID = 8.5 A, VGS = 10 V (Note 4) f = 1 MHz VDS = 10 V (Note 4) = 10 V (Note 4) D = 10 V, Rg = 4.7 \Omega (Note 4) = 10 V (Note 4)		7.9		nC
Q _{gd}	Gate to Drain "Miller" Charge			14		nC
ESR	Equivalent Series Resistance	f = 1 MHz		0.5		Ω
WITCHING CH	IARACTERISTICS					
t _{d(on)}	Turn–On Delay Time	V _{DD} = 400 V, I _D = 8.5 A,		17		ns
t _r	Turn–On Rise Time	- V _{GS} = 10 V, R _g = 4.7 Ω (Note 4)		16		ns
t _{d(off)}	Turn–Off Delay Time			42		ns
t _f	Turn-Off Fall Time			6	1	ns
OURCE-DRA	IN DIODE CHARACTERISTICS			•	•	
I _S	Maximum Continuous Source to Drain Diode Forward Current				17	Α
I _{SM}	Maximum Pulsed Source to Drair	n Diode Forward Current			42.5	Α
V _{SD}	Source to Drain Diode Forward Voltage	V_{GS} = 0 V, I _{SD} = 8.5 A			1.2	V

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Essentially independent of operating temperature typical characteristics.

 $\label{eq:VDD} \begin{array}{l} V_{DD} = 400 \text{ V}, \text{ I}_{SD} = 8.5 \text{ A}, \\ \text{ dI}_{\text{F}}/\text{dt} = 100 \text{ A/ms} \end{array}$

313

4.9

ns μC

Reverse Recovery Time

Reverse Recovery Charge

t_{rr}

Q_{rr}

TYPICAL PERFORMANCE CHARACTERISTICS

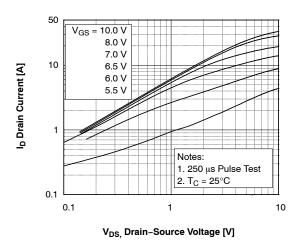
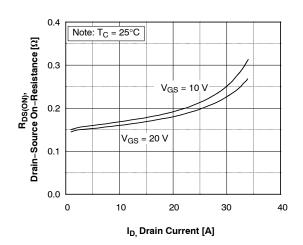
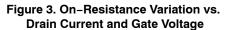


Figure 1. On-Region Characteristics





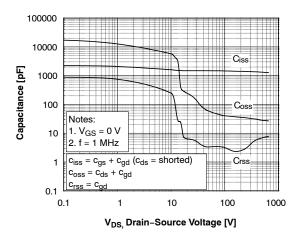


Figure 5. Capacitance Characteristics

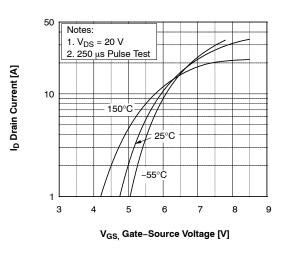
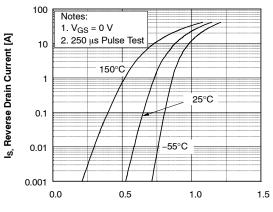


Figure 2. Transfer Characteristics



V_{SD,} Body Diode Forward Voltage [V]

Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

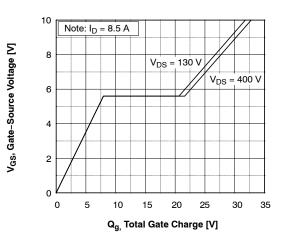
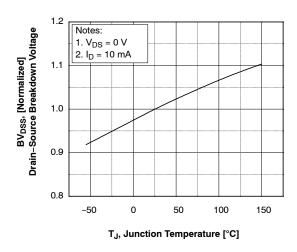
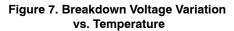


Figure 6. Gate Charge Characteristics

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)





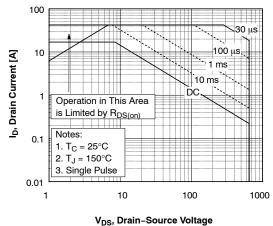
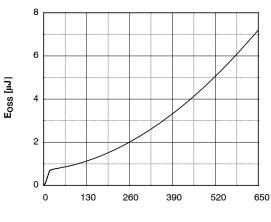


Figure 9. Maximum Safe Operating Area



V_{DS}, Drain to Source Voltage

Figure 11. E_{oss} vs. Drain to Source Voltage

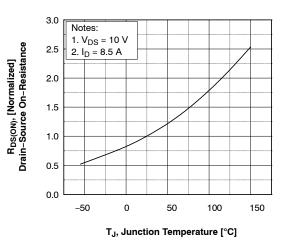


Figure 8. On–Resistance Variation vs. Temperature

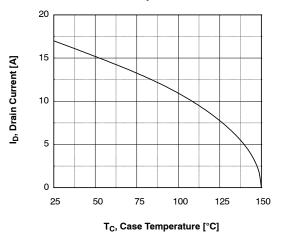


Figure 10. Maximum Drain Current vs. Case Temperature

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

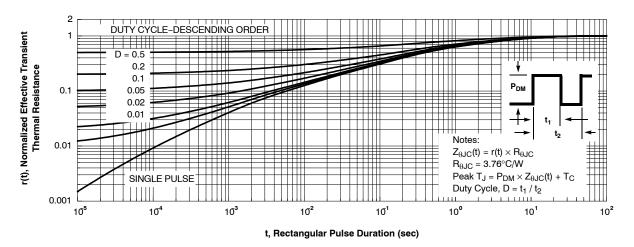
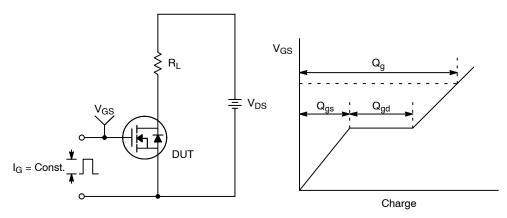


Figure 12. Transient Thermal Response Curve





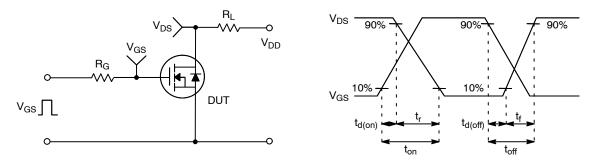


Figure 14. Resistive Switching Test Circuit & Waveforms

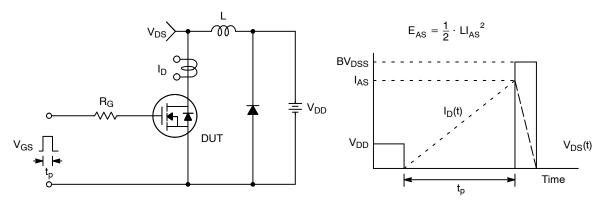


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

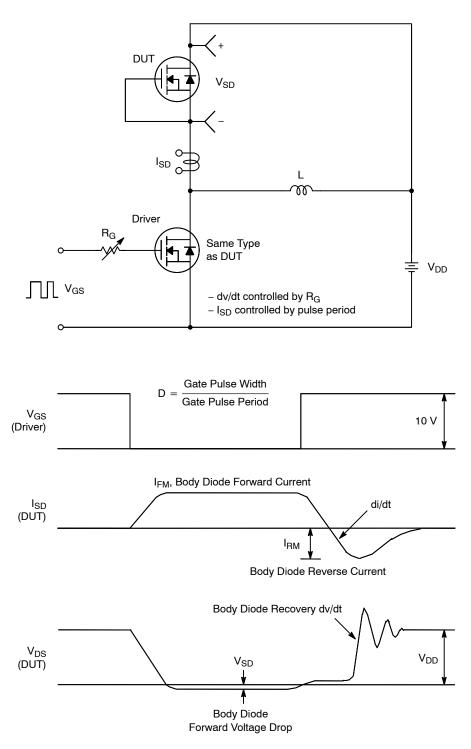


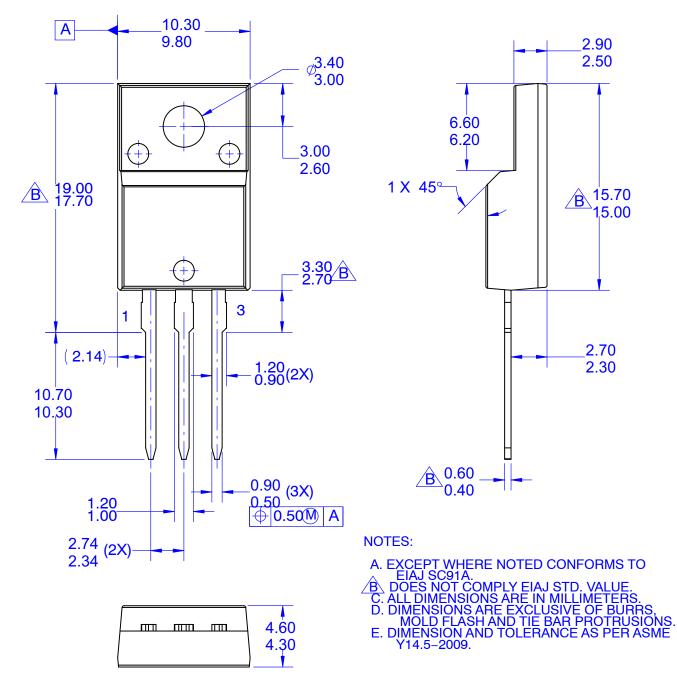
Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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DATE 31 AUG 2016



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